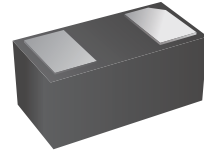




Ultra Low Capacitance ESD Protection Diode

Features

- Transient protection for high-speed data lines
IEC 61000-4-2 (ESD) ±15kV (Contact)
±20kV (Air)
- Cable Discharge Event (CDE)
- Package optimized for high-speed lines
- Ultra-small package (1.0mm×0.6mm×0.5mm)
- Protects one data, control line
- Low capacitance: 0.25pF (Typical)
- Low leakage current
- Low clamping voltage
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case:DFN1006
- Flammability Rating: UL 94V-0

Applications

- Local Area Network (LAN) equipment
- FireWire
- Computers and peripherals
- Communication systems
- High-speed data lines

Ordering Information

Part Number	Marking	Shipping	Reel
LTE10N15C01LG-TR10	15BU	10000PCS Tape&Reel	7 inches

Absolute Maximum Ratings (Tamb=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{ESD}	ESD per IEC 61000-4-2 (Contact) ESD per IEC 61000-4-2 (Air)	±15 ±20	kV
P _{PP}	Peak Pulse Power (8/20μs)	70	W
T _{OPT}	Operating Temperature	-55~125	°C
T _{STG}	Storage Temperature	-55~150	°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
V _{RWM}	Reverse Working Voltage				15	V
V _{BR}	Reverse Breakdown Voltage	I _T = 1mA	16			V
I _R	Reverse Leakage Current	V _{RWM} = 15V			500	nA
V _C	Clamping Voltage	I _{PP} = 1A, t _p = 8/20μs			25	V
		I _{PP} = 2A, t _p = 8/20μs			35	V
C _J	Junction Capacitance	V _R = 0V, f = 1MHz		0.25	0.40	pF



Characteristic Curves

Fig.1 Power Derating Curve

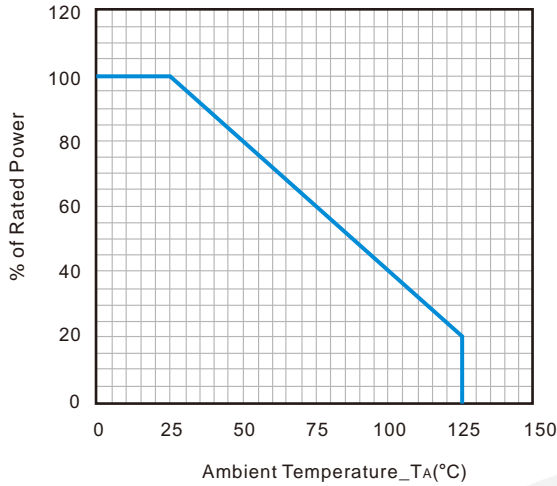


Fig.2 8x20us Pulse Waveform

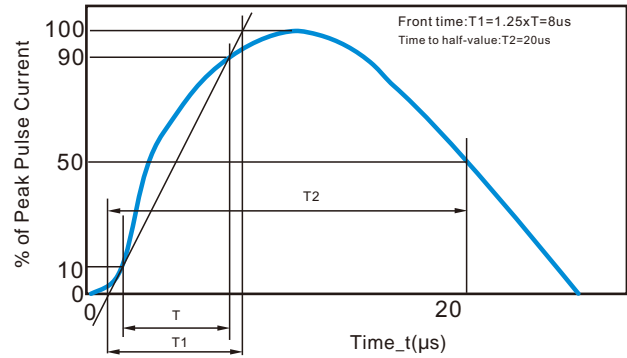


Fig.3 Clamping Voltage vs Peak Pulse Current

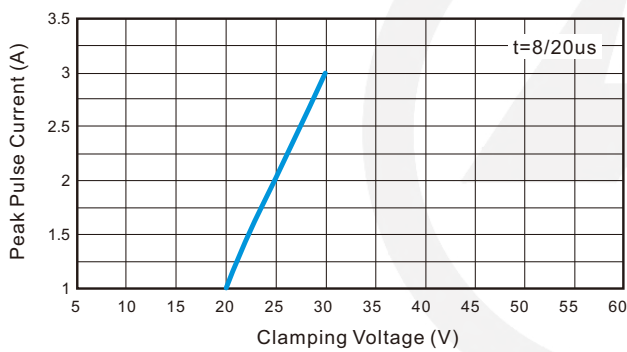


Fig.4 Voltage vs Capacitance

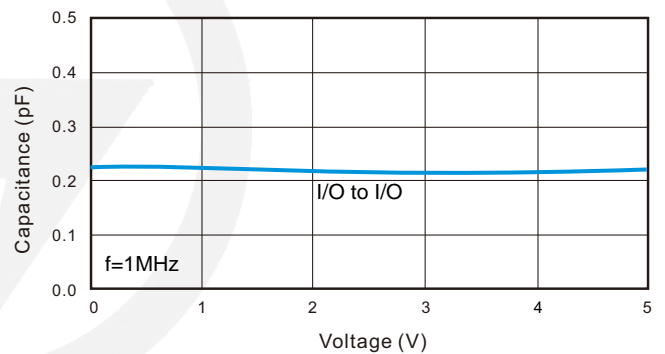


Fig.5 ESD Clamping (+8kV Contact per IEC 61000-4-2)

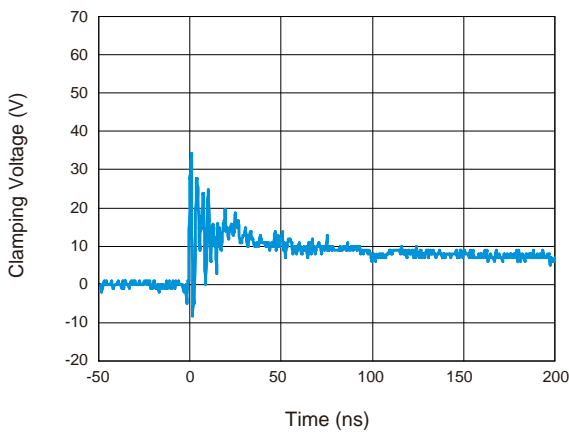
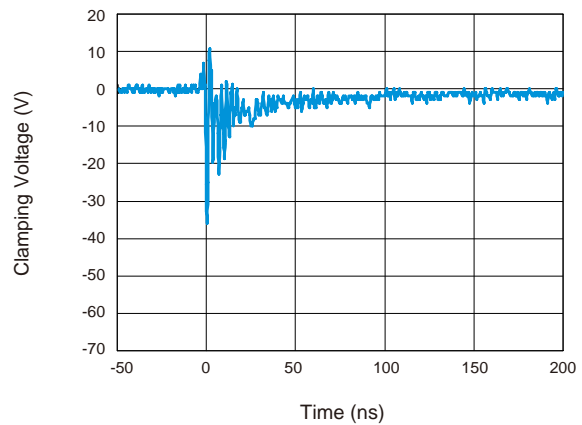
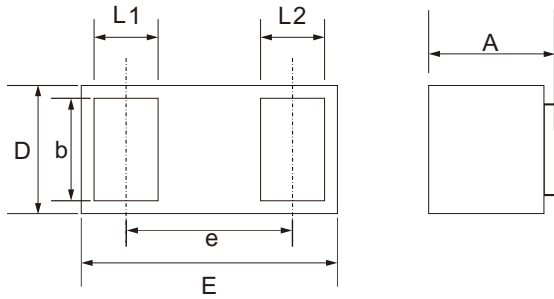


Fig.6 ESD Clamping (-8kV Contact per IEC 61000-4-2)



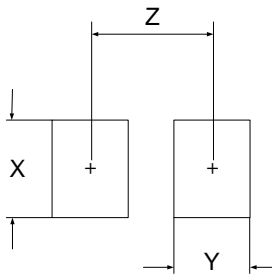
DFN1006 Package Outline

Unit: mm



SYMBOL	DIMENSIONS	
	MIN.	MAX.
D	0.550	0.650
E	0.950	1.050
L1	0.200	0.300
L2	0.200	0.300
b	0.450	0.550
e	0.650 TYP.	
A	0.450	0.550

DFN1006 Suggested Pad Layout



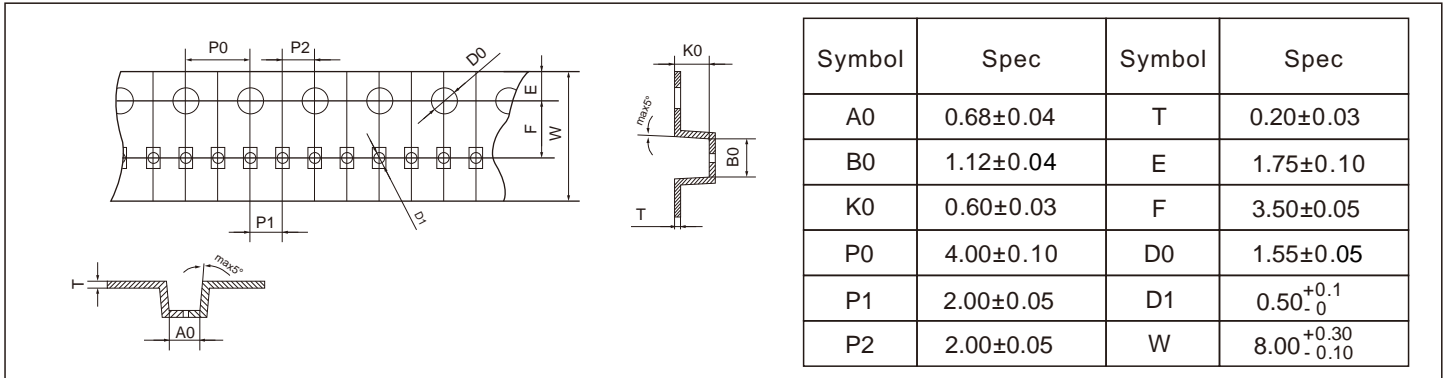
SYM	DIMENSIONS
	MILLIMETERS
X	0.50
Y	0.50
Z	0.90

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$
3. The pad layout is for reference purpose only.

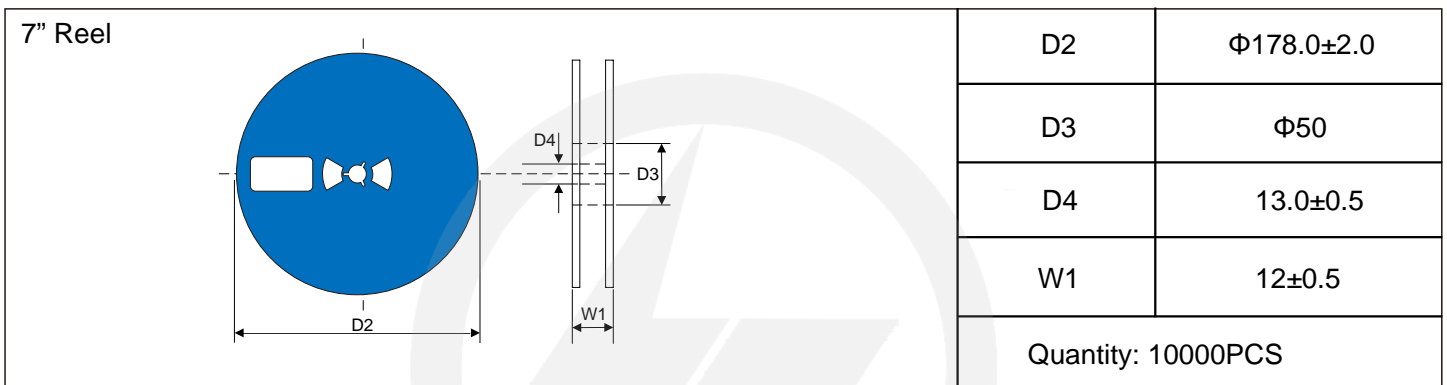
Carrier Tape Dimensions

Unit : mm

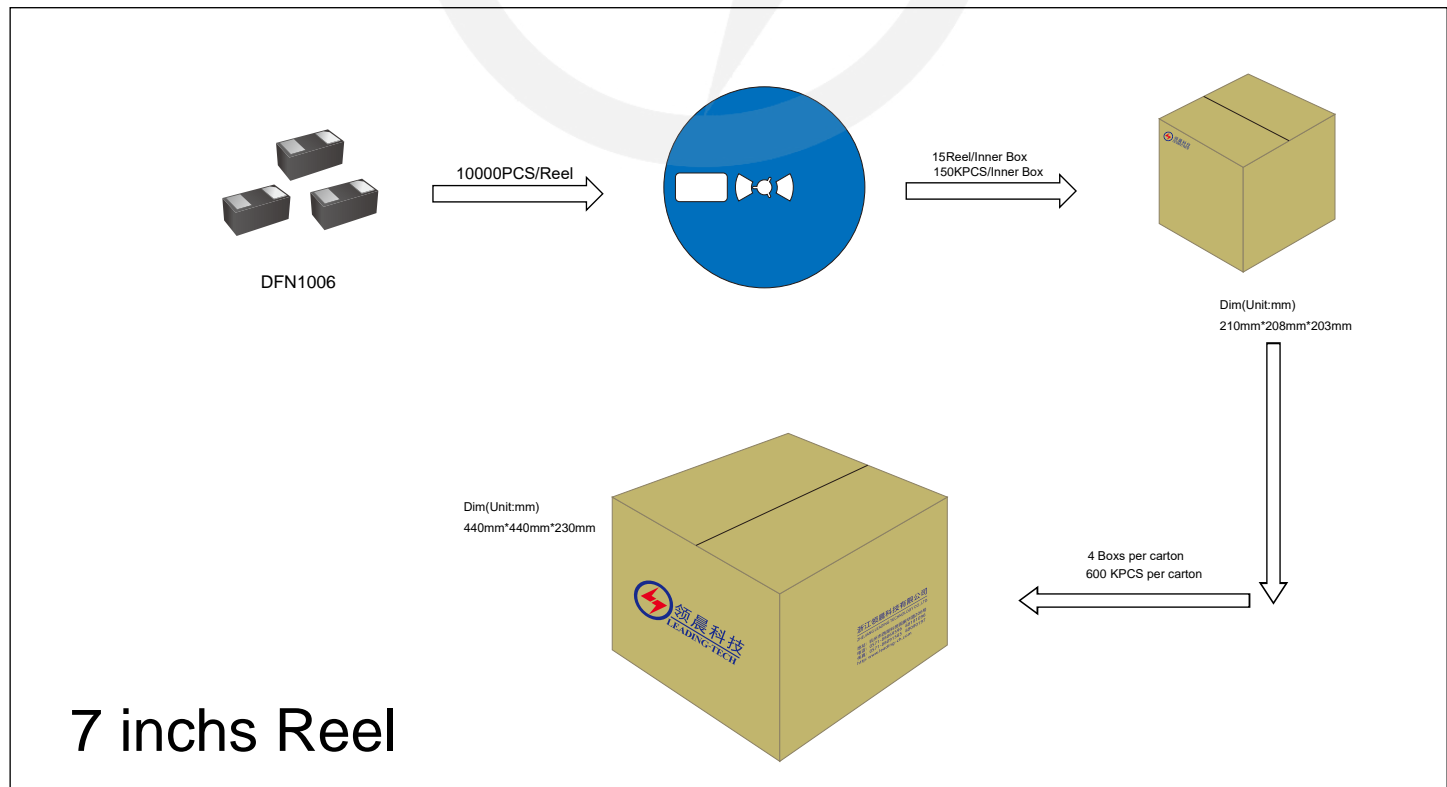


Reel Dimensions

Unit : mm



Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Important Notice and Disclaimer

Leading-Tech reserves the right to make changes to this document and its products and specifications at any time without notice.

Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Leading-Tech makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Leading-Tech assume any liability for application assistance or customer product design.

Leading-tech does not warrant or accept any liability with products which are purchase or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Leading-Tech.

Leading-Tech products are not authorized for use as critical components in life support devices or systems without express written approval of Leading-tech.

Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision content	Revision Reason	Revision Person	Note
01	2024.08.11	2024.08.11	3.0	New File	/	Ding	